




# Power MOSFETS


## DATASHEET


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**LM60400DAQ8A**

Dual N-Channel  
Enhancement Mode MOSFET

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Quality Management Systems

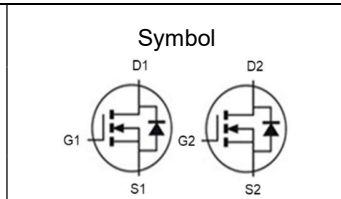
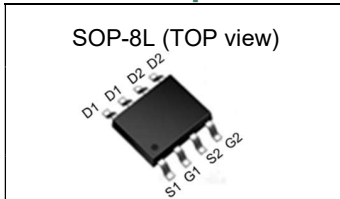
ISO 9001:2015 Certificate

# LM60400DAQ8A



## Dual N-Channel Enhancement Mode MOSFET

### Pin Description



### Ordering Information

Symbol	Dual N-Channel	Unit
$V_{DSS}$	<b>60</b>	<b>V</b>
$R_{DS(ON)-Max}$	<b>39</b>	<b>m<math>\Omega</math></b>
$I_D$	<b>4.8</b>	<b>A</b>

### Feature

- Dual N Channel MOSFET
- Fast switching speed
- ROHS Compliant & Halogen-Free
- Reliable and Rugged

### Applications

- DC-DC Converters
- White LED boost converters

### Ordering Information

Orderable Part Number	Package Type	Form	Shipping	Marking
LM60400DAQ8A	SOP-8L	Tape & Reel	3000 / Tape & Reel	60400 □□□□□□

### Absolute Maximum Ratings (T<sub>J</sub>=25°C Unless Otherwise Noted)

Symbol	Parameter		Dual N-Channel	Unit
$V_{DSS}$	Drain-Source Voltage		60	V
$V_{GSS}$	Gate-Source Voltage		±20	
$T_J$	Maximum Junction Temperature		150	°C
$T_{STG}$	Storage Temperature Range		-55 to 150	°C
$I_{DM}^{①}$	Pulse Drain Current Tested	$T_A=25^\circ\text{C}$	12	A
$I_D$	Continuous Drain Current	$T_A=25^\circ\text{C}$	4.8	A
		$T_A=100^\circ\text{C}$	3.8	
$P_D$	Maximum Power Dissipation	$T_A=25^\circ\text{C}$	1.7	W
		$T_A=70^\circ\text{C}$	1.1	
$I_{AS}^{②}$	Avalanche Current, Single pulse	L=0.1mH	17	A
$E_{AS}^{③}$	Avalanche Energy, Single pulse	L=0.1mH	14.5	mJ

### Thermal Characteristics

Symbol	Parameter		Rating	Unit
$R_{\theta JA}^{③}$	Thermal Resistance-Junction to Ambient	t≤10s	48	°C/W
		Steady State	74	°C/W

Note ① : Max. current is limited by junction temperature.

Note ② : UIS tested and pulse width are limited by maximum junction temperature 150°C

Note ③ : Surface Mounted on 1in<sup>2</sup> FR-4 board with 1oz.

## N -Channel Electrical Characteristics (T<sub>J</sub>=25°C Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
<b>Static Electrical Characteristics</b>						
<b>BV<sub>DSS</sub></b>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>DS</sub> =250uA	60	-	-	V
<b>I<sub>DSS</sub></b>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =48V, V <sub>GS</sub> =0V	-	-	1	uA
<b>V<sub>GS(th)</sub></b>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>DS</sub> =250uA	1.2	1.8	2.5	V
<b>I<sub>GSS</sub></b>	Gate Leakage Current	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V	-	-	±100	nA
<b>R<sub>DS(ON)</sub></b> <sup>④</sup>	Drain-Source On-state Resistance	V <sub>GS</sub> =10V, I <sub>DS</sub> =10A	-	33	39	mΩ
		V <sub>GS</sub> =4.5V, I <sub>DS</sub> =8A	-	36	47	
<b>gfs</b>	Forward Transconductance	V <sub>DS</sub> =5V, I <sub>DS</sub> =10A	-	10	-	S
<b>Dynamic Characteristics</b> <sup>⑤</sup>						
<b>R<sub>G</sub></b>	Gate Resistance	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, Freq.=1MHz	-	3.8	-	Ω
<b>C<sub>iss</sub></b>	Input Capacitance	V <sub>GS</sub> =0V, V <sub>DS</sub> =30V, Freq.=1MHz	-	1108	-	pF
<b>C<sub>oss</sub></b>	Output Capacitance		-	65	-	
<b>C<sub>rss</sub></b>	Reverse Transfer Capacitance		-	44	-	
<b>td(ON)</b>	Turn-on Delay Time	V <sub>GS</sub> =10V, V <sub>DS</sub> =30V, I <sub>D</sub> =1A, R <sub>GEN</sub> =6Ω	-	6	-	nS
<b>t<sub>r</sub></b>	Turn-on Rise Time		-	21	-	
<b>t<sub>d(OFF)</sub></b>	Turn-off Delay Time		-	44	-	
<b>t<sub>f</sub></b>	Turn-off Fall Time		-	20	-	
<b>Q<sub>g</sub></b>	Total Gate Charge	V <sub>GS</sub> =4.5V, V <sub>DS</sub> =30V I <sub>D</sub> =10A	-	13	-	nC
<b>Q<sub>g</sub></b>	Total Gate Charge	V <sub>GS</sub> =10V, V <sub>DS</sub> =30V, I <sub>D</sub> =10A	-	26	-	
<b>Q<sub>gs</sub></b>	Gate-Source Charge		-	3.9	-	
<b>Q<sub>gd</sub></b>	Gate-Drain Charge		-	4.8	-	
<b>Source-Drain Characteristics</b>						
<b>V<sub>SD</sub></b> <sup>④</sup>	Diode Forward Voltage	I <sub>SD</sub> =1A, V <sub>GS</sub> =0V	-	0.75	1.1	V
<b>t<sub>rr</sub></b>	Reverse Recovery Time	I <sub>F</sub> =1A, V <sub>GS</sub> =0V	-	19.6	-	nS
<b>Q<sub>rr</sub></b>	Reverse Recovery Charge	di <sub>F</sub> /dt=100A/μs	-	15.1	-	nC

Note ④ : Pulse test (pulse width≤300us, duty cycle≤2%).

Note ⑤ : Guaranteed by design, not subject to production testing.

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## N -Channel Typical Characteristics

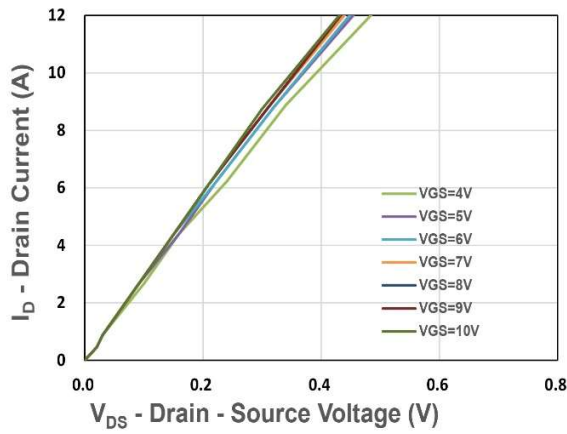


Figure 1. Output Characteristics

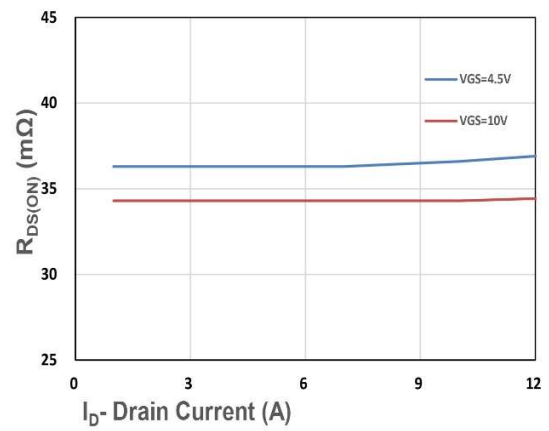


Figure 2. On-Resistance vs. ID

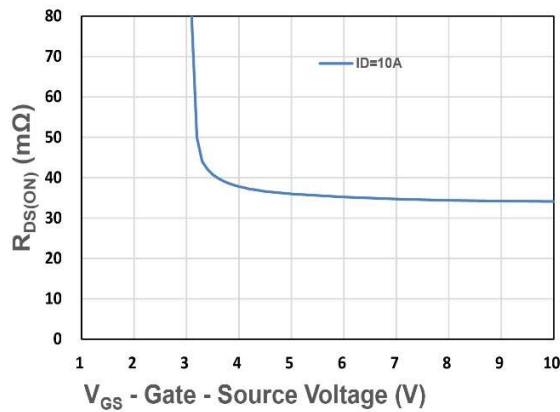


Figure 3. On-Resistance vs. VGS

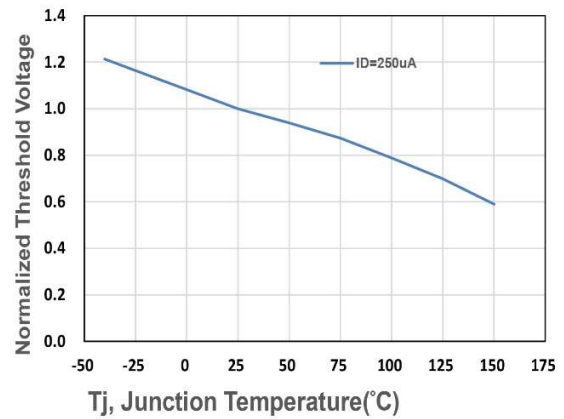


Figure 4. Gate Threshold Voltage

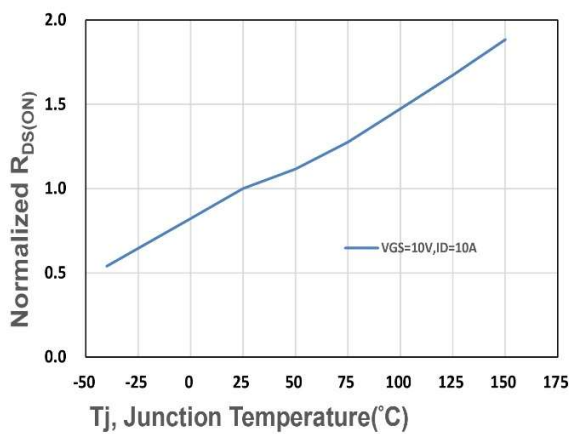


Figure 5. Drain-Source On Resistance

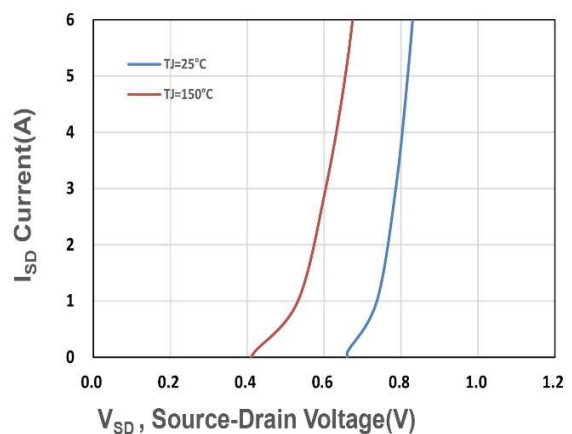


Figure 6. Source-Drain Diode Forward

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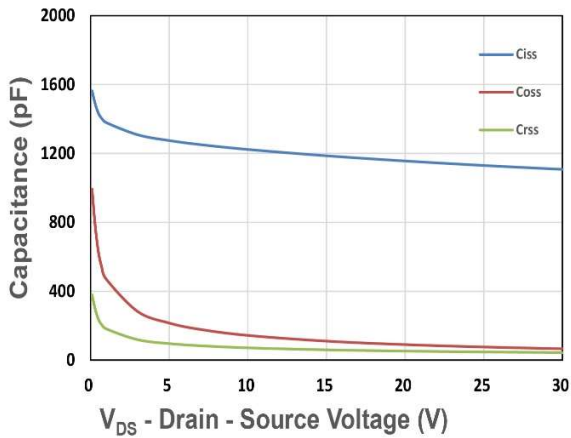


Figure 7. Capacitance

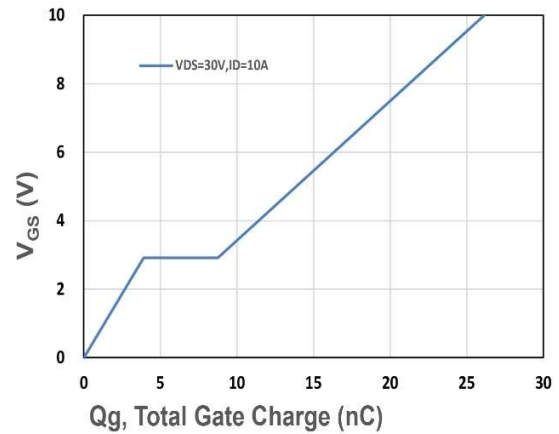


Figure 8. Gate Charge Characteristics

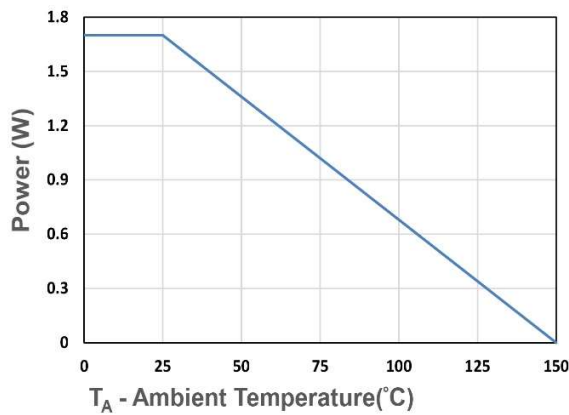


Figure 9. Power Dissipation

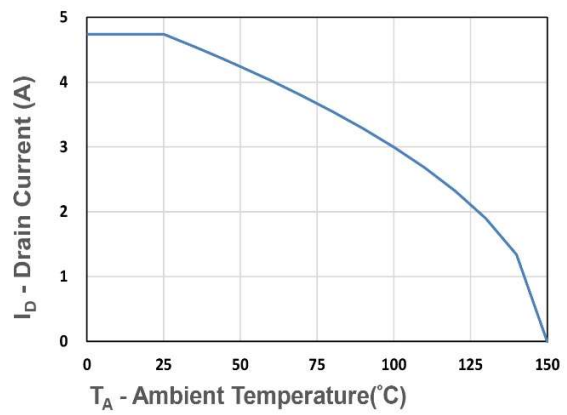


Figure 10. Drain Current

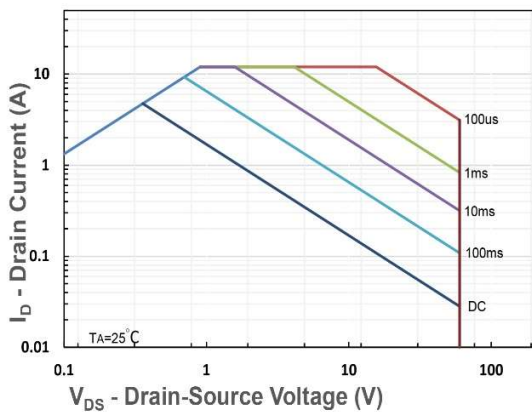


Figure 11. Safe Operating Area

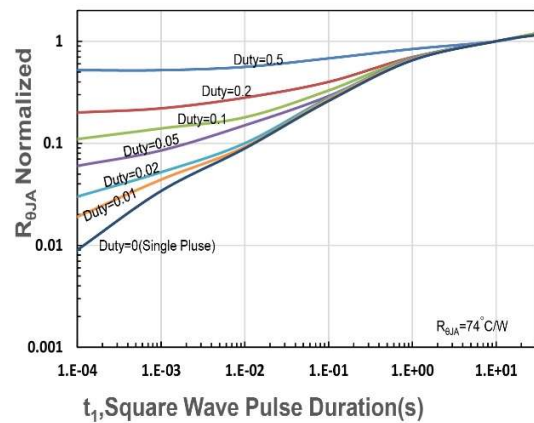


Figure 12.  $R_{\theta JA}$  Transient Thermal Impedance